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"[Embedded - Microcontrollers](#)" refer to small, integrated circuits designed to perform specific tasks within larger systems. These microcontrollers are essentially compact computers on a single chip, containing a processor core, memory, and programmable input/output peripherals. They are called "embedded" because they are embedded within electronic devices to control various functions, rather than serving as standalone computers. Microcontrollers are crucial in modern electronics, providing the intelligence and control needed for a wide range of applications.

Applications of "[Embedded - Microcontrollers](#)"

Details

| | |
|----------------------------|---|
| Product Status | Active |
| Core Processor | PIC |
| Core Size | 8-Bit |
| Speed | 4MHz |
| Connectivity | - |
| Peripherals | Brown-out Detect/Reset, POR, WDT |
| Number of I/O | 13 |
| Program Memory Size | 1.75KB (1K x 14) |
| Program Memory Type | OTP |
| EEPROM Size | - |
| RAM Size | 80 x 8 |
| Voltage - Supply (Vcc/Vdd) | 2.5V ~ 6V |
| Data Converters | - |
| Oscillator Type | External |
| Operating Temperature | -40°C ~ 85°C (TA) |
| Mounting Type | Surface Mount |
| Package / Case | 18-SOIC (0.295", 7.50mm Width) |
| Supplier Device Package | 18-SOIC |
| Purchase URL | https://www.e-xfl.com/product-detail/microchip-technology/pic16lc621-04i-so |

PIC16C62X

Device Differences

| Device | Voltage Range | Oscillator | Process Technology (Microns) |
|----------------------------|---------------|-------------------|------------------------------|
| PIC16C620 ⁽³⁾ | 2.5 - 6.0 | See Note 1 | 0.9 |
| PIC16C621 ⁽³⁾ | 2.5 - 6.0 | See Note 1 | 0.9 |
| PIC16C622 ⁽³⁾ | 2.5 - 6.0 | See Note 1 | 0.9 |
| PIC16C620A ⁽⁴⁾ | 2.7 - 5.5 | See Note 1 | 0.7 |
| PIC16CR620A ⁽²⁾ | 2.5 - 5.5 | See Note 1 | 0.7 |
| PIC16C621A ⁽⁴⁾ | 2.7 - 5.5 | See Note 1 | 0.7 |
| PIC16C622A ⁽⁴⁾ | 2.7 - 5.5 | See Note 1 | 0.7 |

Note 1: If you change from this device to another device, please verify oscillator characteristics in your application.

2: For ROM parts, operation from 2.5V - 3.0V will require the PIC16LCR62X parts.

3: For OTP parts, operation from 2.5V - 3.0V will require the PIC16LC62X parts.

4: For OTP parts, operations from 2.7V - 3.0V will require the PIC16LC62XA parts.

PIC16C62X

NOTES:

1.0 GENERAL DESCRIPTION

The PIC16C62X devices are 18 and 20-Pin ROM/EPROM-based members of the versatile PICmicro® family of low cost, high performance, CMOS, fully-static, 8-bit microcontrollers.

All PICmicro microcontrollers employ an advanced RISC architecture. The PIC16C62X devices have enhanced core features, eight-level deep stack, and multiple internal and external interrupt sources. The separate instruction and data buses of the Harvard architecture allow a 14-bit wide instruction word with the separate 8-bit wide data. The two-stage instruction pipeline allows all instructions to execute in a single cycle, except for program branches (which require two cycles). A total of 35 instructions (reduced instruction set) are available. Additionally, a large register set gives some of the architectural innovations used to achieve a very high performance.

PIC16C62X microcontrollers typically achieve a 2:1 code compression and a 4:1 speed improvement over other 8-bit microcontrollers in their class.

The PIC16C620A, PIC16C621A and PIC16CR620A have 96 bytes of RAM. The PIC16C622(A) has 128 bytes of RAM. Each device has 13 I/O pins and an 8-bit timer/counter with an 8-bit programmable prescaler. In addition, the PIC16C62X adds two analog comparators with a programmable on-chip voltage reference module. The comparator module is ideally suited for applications requiring a low cost analog interface (e.g., battery chargers, threshold detectors, white goods controllers, etc).

PIC16C62X devices have special features to reduce external components, thus reducing system cost, enhancing system reliability and reducing power consumption. There are four oscillator options, of which the single pin RC oscillator provides a low cost solution, the LP oscillator minimizes power consumption, XT is a standard crystal, and the HS is for High Speed crystals. The SLEEP (Power-down) mode offers power savings. The user can wake-up the chip from SLEEP through several external and internal interrupts and RESET.

A highly reliable Watchdog Timer with its own on-chip RC oscillator provides protection against software lock-up.

A UV-erasable Cerdip-packaged version is ideal for code development while the cost effective One-Time-Programmable (OTP) version is suitable for production in any volume.

Table 1-1 shows the features of the PIC16C62X mid-range microcontroller families.

A simplified block diagram of the PIC16C62X is shown in Figure 3-1.

The PIC16C62X series fits perfectly in applications ranging from battery chargers to low power remote sensors. The EPROM technology makes

customization of application programs (detection levels, pulse generation, timers, etc.) extremely fast and convenient. The small footprint packages make this microcontroller series perfect for all applications with space limitations. Low cost, low power, high performance, ease of use and I/O flexibility make the PIC16C62X very versatile.

1.1 Family and Upward Compatibility

Those users familiar with the PIC16C5X family of microcontrollers will realize that this is an enhanced version of the PIC16C5X architecture. Please refer to Appendix A for a detailed list of enhancements. Code written for the PIC16C5X can be easily ported to PIC16C62X family of devices (Appendix B). The PIC16C62X family fills the niche for users wanting to migrate up from the PIC16C5X family and not needing various peripheral features of other members of the PIC16XX mid-range microcontroller family.

1.2 Development Support

The PIC16C62X family is supported by a full-featured macro assembler, a software simulator, an in-circuit emulator, a low cost development programmer and a full-featured programmer. Third Party "C" compilers are also available.

4.2.2 SPECIAL FUNCTION REGISTERS

The Special Function Registers are registers used by the CPU and Peripheral functions for controlling the desired operation of the device (Table 4-1). These registers are static RAM.

The Special Function Registers can be classified into two sets (core and peripheral). The Special Function Registers associated with the “core” functions are described in this section. Those related to the operation of the peripheral features are described in the section of that peripheral feature.

TABLE 4-1: SPECIAL REGISTERS FOR THE PIC16C62X

| Address | Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Value on POR Reset | Value on all other RESETS ⁽¹⁾ |
|---------------|---------------|--|--------------------|--------|--|------------------|------------------|------------------|------------------|--------------------|--|
| Bank 0 | | | | | | | | | | | |
| 00h | INDF | Addressing this location uses contents of FSR to address data memory (not a physical register) | | | | | | | | xxxx xxxx | xxxx xxxx |
| 01h | TMR0 | Timer0 Module's Register | | | | | | | | xxxx xxxx | uuuu uuuu |
| 02h | PCL | Program Counter's (PC) Least Significant Byte | | | | | | | | 0000 0000 | 0000 0000 |
| 03h | STATUS | IRP ⁽²⁾ | RP1 ⁽²⁾ | RP0 | \overline{TO} | \overline{PD} | Z | DC | C | 0001 1xxx | 000q quuu |
| 04h | FSR | Indirect data memory address pointer | | | | | | | | xxxx xxxx | uuuu uuuu |
| 05h | PORTA | — | — | — | $\overline{RA4}$ | $\overline{RA3}$ | $\overline{RA2}$ | $\overline{RA1}$ | RA0 | ---x 0000 | ---u 0000 |
| 06h | PORTB | RB7 | RB6 | RB5 | $\overline{RB4}$ | $\overline{RB3}$ | $\overline{RB2}$ | $\overline{RB1}$ | RB0 | xxxx xxxx | uuuu uuuu |
| 07h-09h | Unimplemented | | | | | | | | | — | — |
| 0Ah | PCLATH | — | — | — | Write buffer for upper 5 bits of program counter | | | | | ---0 0000 | ---0 0000 |
| 0Bh | INTCON | GIE | PEIE | TOIE | INTE | RBIE | TOIF | INTF | RBIF | 0000 000x | 0000 000u |
| 0Ch | PIR1 | — | CMIF | — | — | — | — | — | — | -0-- ---- | -0-- ---- |
| 0Dh-1Eh | Unimplemented | | | | | | | | | — | — |
| 1Fh | CMCON | C2OUT | C1OUT | — | — | CIS | CM2 | CM1 | CM0 | 00-- 0000 | 00-- 0000 |
| Bank 1 | | | | | | | | | | | |
| 80h | INDF | Addressing this location uses contents of FSR to address data memory (not a physical register) | | | | | | | | xxxx xxxx | xxxx xxxx |
| 81h | OPTION | \overline{RBPU} | INTEDG | T0CS | T0SE | PSA | PS2 | PS1 | PS0 | 1111 1111 | 1111 1111 |
| 82h | PCL | Program Counter's (PC) Least Significant Byte | | | | | | | | 0000 0000 | 0000 0000 |
| 83h | STATUS | IRP ⁽²⁾ | RP1 ⁽²⁾ | RP0 | \overline{TO} | \overline{PD} | Z | DC | C | 0001 1xxx | 000q quuu |
| 84h | FSR | Indirect data memory address pointer | | | | | | | | xxxx xxxx | uuuu uuuu |
| 85h | TRISA | — | — | — | TRISA4 | TRISA3 | TRISA2 | TRISA1 | TRISA0 | ---1 1111 | ---1 1111 |
| 86h | TRISB | TRISB7 | TRISB6 | TRISB5 | TRISB4 | TRISB3 | TRISB2 | TRISB1 | TRISB0 | 1111 1111 | 1111 1111 |
| 87h-89h | Unimplemented | | | | | | | | | — | — |
| 8Ah | PCLATH | — | — | — | Write buffer for upper 5 bits of program counter | | | | | ---0 0000 | ---0 0000 |
| 8Bh | INTCON | GIE | PEIE | TOIE | INTE | RBIE | TOIF | INTF | RBIF | 0000 000x | 0000 000u |
| 8Ch | PIE1 | — | CMIE | — | — | — | — | — | — | -0-- ---- | -0-- ---- |
| 8Dh | Unimplemented | | | | | | | | | — | — |
| 8Eh | PCON | — | — | — | — | — | — | POR | \overline{BOR} | ---- --0x | ---- --uq |
| 8Fh-9Eh | Unimplemented | | | | | | | | | — | — |
| 9Fh | VRCON | VREN | VROE | VRR | — | VR3 | VR2 | VR1 | VR0 | 000- 0000 | 000- 0000 |

Legend: — = Unimplemented locations read as '0', u = unchanged, x = unknown,
q = value depends on condition, shaded = unimplemented

Note 1: Other (non Power-up) Resets include MCLR Reset, Brown-out Reset and Watchdog Timer Reset during normal operation.

2: IRP & RP1 bits are reserved; always maintain these bits clear.

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4.2.2.3 INTCON Register

The INTCON register is a readable and writable register, which contains the various enable and flag bits for all interrupt sources except the comparator module. See Section 4.2.2.4 and Section 4.2.2.5 for a description of the comparator enable and flag bits.

Note: Interrupt flag bits get set when an interrupt condition occurs, regardless of the state of its corresponding enable bit or the global enable bit, GIE (INTCON<7>).

REGISTER 4-3: INTCON REGISTER (ADDRESS 0BH OR 8BH)

| R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-0 | R/W-x |
|-------|-------|-------|-------|-------|-------|-------|-------|
| GIE | PEIE | TOIE | INTE | RBIE | TOIF | INTF | RBIF |
| bit 7 | | | | | | | bit 0 |

- bit 7 **GIE:** Global Interrupt Enable bit
1 = Enables all un-masked interrupts
0 = Disables all interrupts
- bit 6 **PEIE:** Peripheral Interrupt Enable bit
1 = Enables all un-masked peripheral interrupts
0 = Disables all peripheral interrupts
- bit 5 **TOIE:** TMR0 Overflow Interrupt Enable bit
1 = Enables the TMR0 interrupt
0 = Disables the TMR0 interrupt
- bit 4 **INTE:** RB0/INT External Interrupt Enable bit
1 = Enables the RB0/INT external interrupt
0 = Disables the RB0/INT external interrupt
- bit 3 **RBIE:** RB Port Change Interrupt Enable bit
1 = Enables the RB port change interrupt
0 = Disables the RB port change interrupt
- bit 2 **TOIF:** TMR0 Overflow Interrupt Flag bit
1 = TMR0 register has overflowed (must be cleared in software)
0 = TMR0 register did not overflow
- bit 1 **INTF:** RB0/INT External Interrupt Flag bit
1 = The RB0/INT external interrupt occurred (must be cleared in software)
0 = The RB0/INT external interrupt did not occur
- bit 0 **RBIF:** RB Port Change Interrupt Flag bit
1 = When at least one of the RB<7:4> pins changed state (must be cleared in software)
0 = None of the RB<7:4> pins have changed state

Legend:

| | | |
|--------------------|------------------|--|
| R = Readable bit | W = Writable bit | U = Unimplemented bit, read as '0' |
| - n = Value at POR | '1' = Bit is set | '0' = Bit is cleared x = Bit is unknown |

TABLE 5-1: PORTA FUNCTIONS

| Name | Bit # | Buffer Type | Function |
|--------------|-------|-------------|--|
| RA0/AN0 | bit0 | ST | Input/output or comparator input |
| RA1/AN1 | bit1 | ST | Input/output or comparator input |
| RA2/AN2/VREF | bit2 | ST | Input/output or comparator input or VREF output |
| RA3/AN3 | bit3 | ST | Input/output or comparator input/output |
| RA4/T0CKI | bit4 | ST | Input/output or external clock input for TMR0 or comparator output. Output is open drain type. |

Legend: ST = Schmitt Trigger input

TABLE 5-2: SUMMARY OF REGISTERS ASSOCIATED WITH PORTA

| Address | Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Value on POR | Value on All Other RESETS |
|---------|-------|-------|-------|-------|------------|------------|------------|------------|------------|--------------|---------------------------|
| 05h | PORTA | — | — | — | RA4 | RA3 | RA2 | RA1 | RA0 | ---x 0000 | ---u 0000 |
| 85h | TRISA | — | — | — | TRISA 4 | TRISA 3 | TRISA 2 | TRISA 1 | TRISA 0 | ---1 1111 | ---1 1111 |
| 1Fh | CMCON | C2OUT | C1OUT | — | — | CIS | CM2 | CM1 | CM0 | 00-- 0000 | 00-- 0000 |
| 9Fh | VRCON | VREN | VROE | VRR | — | VR3 | VR2 | VR1 | VR0 | 000- 0000 | 000- 0000 |

Legend: — = Unimplemented locations, read as '0', u = unchanged, x = unknown

Note: Shaded bits are not used by PORTA.

5.2 PORTB and TRISB Registers

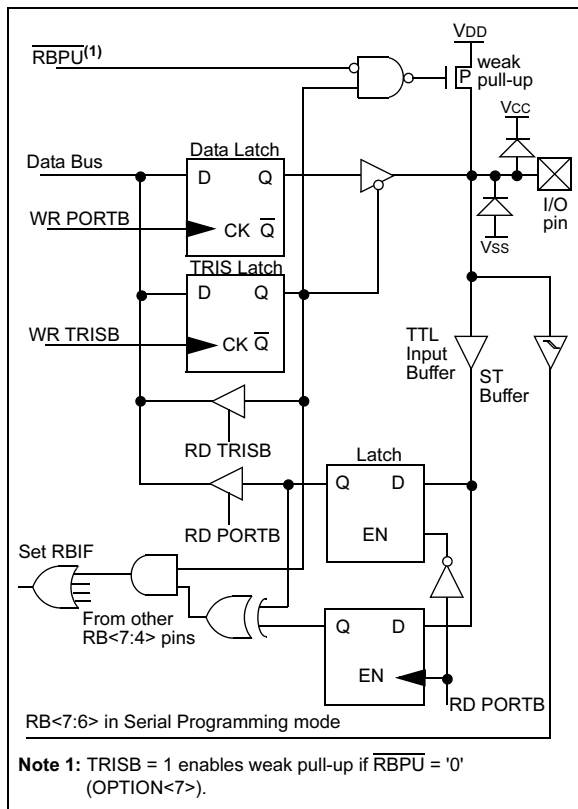
PORTB is an 8-bit wide, bi-directional port. The corresponding data direction register is TRISB. A '1' in the TRISB register puts the corresponding output driver in a High Impedance mode. A '0' in the TRISB register puts the contents of the output latch on the selected pin(s).

Reading PORTB register reads the status of the pins, whereas writing to it will write to the port latch. All write operations are read-modify-write operations. So a write to a port implies that the port pins are first read, then this value is modified and written to the port data latch.

Each of the PORTB pins has a weak internal pull-up ($\approx 200 \mu\text{A}$ typical). A single control bit can turn on all the pull-ups. This is done by clearing the RBPV (OPTION<7>) bit. The weak pull-up is automatically turned off when the port pin is configured as an output. The pull-ups are disabled on Power-on Reset.

Four of PORTB's pins, RB<7:4>, have an interrupt on change feature. Only pins configured as inputs can cause this interrupt to occur (e.g., any RB<7:4> pin configured as an output is excluded from the interrupt on change comparison). The input pins (of RB<7:4>) are compared with the old value latched on the last read of PORTB. The "mismatch" outputs of RB<7:4> are OR'ed together to generate the RBIF interrupt (flag latched in INTCON<0>).

FIGURE 5-5: BLOCK DIAGRAM OF RB<7:4> PINS



This interrupt can wake the device from SLEEP. The user, in the interrupt service routine, can clear the interrupt in the following manner:

- Any read or write of PORTB. This will end the mismatch condition.
- Clear flag bit RBIF.

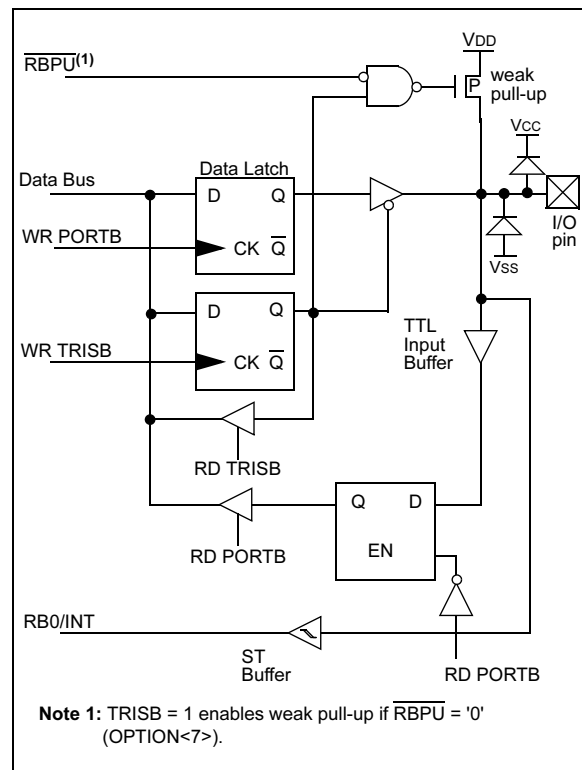
A mismatch condition will continue to set flag bit RBIF. Reading PORTB will end the mismatch condition and allow flag bit RBIF to be cleared.

This interrupt on mismatch feature, together with software configurable pull-ups on these four pins allow easy interface to a key pad and make it possible for wake-up on key-depression. (See AN552, "Implementing Wake-Up on Key Strokes.")

Note: If a change on the I/O pin should occur when the read operation is being executed (start of the Q2 cycle), then the RBIF interrupt flag may not get set.

The interrupt-on-change feature is recommended for wake-up on key depression operation and operations where PORTB is only used for the interrupt on change feature. Polling of PORTB is not recommended while using the interrupt-on-change feature.

FIGURE 5-6: BLOCK DIAGRAM OF RB<3:0> PINS



6.2 Using Timer0 with External Clock

When an external clock input is used for Timer0, it must meet certain requirements. The external clock requirement is due to internal phase clock (Tosc) synchronization. Also, there is a delay in the actual incrementing of Timer0 after synchronization.

6.2.1 EXTERNAL CLOCK SYNCHRONIZATION

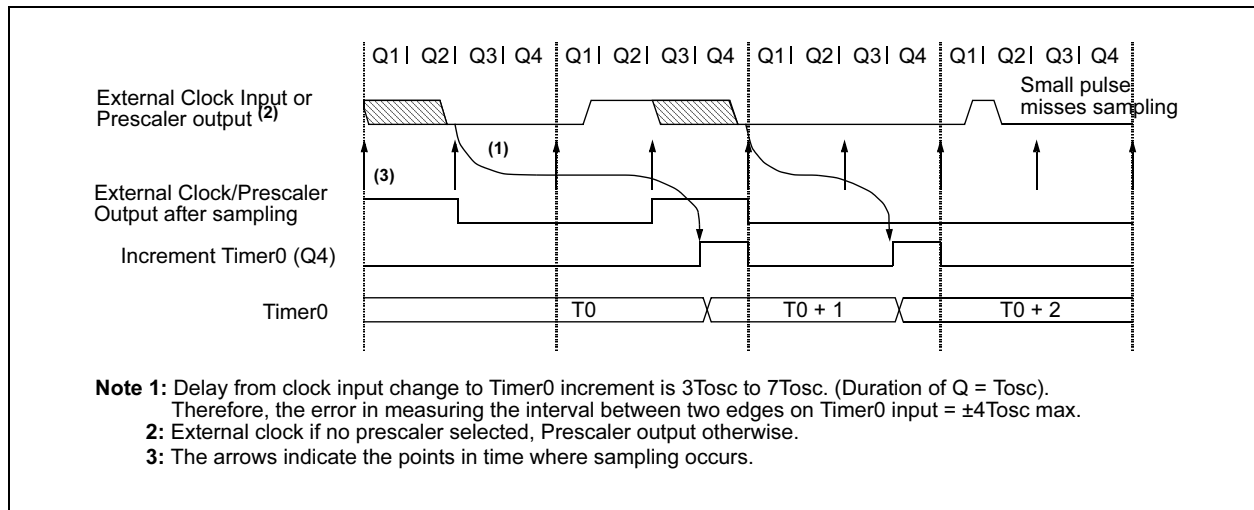
When no prescaler is used, the external clock input is the same as the prescaler output. The synchronization of T0CKI with the internal phase clocks is accomplished by sampling the prescaler output on the Q2 and Q4 cycles of the internal phase clocks (Figure 6-5). Therefore, it is necessary for T0CKI to be high for at least 2Tosc (and a small RC delay of 20 ns) and low for at least 2Tosc (and a small RC delay of 20 ns). Refer to the electrical specification of the desired device.

When a prescaler is used, the external clock input is divided by the asynchronous ripple-counter type prescaler, so that the prescaler output is symmetrical. For the external clock to meet the sampling requirement, the ripple-counter must be taken into account. Therefore, it is necessary for T0CKI to have a period of at least 4Tosc (and a small RC delay of 40 ns) divided by the prescaler value. The only requirement on T0CKI high and low time is that they do not violate the minimum pulse width requirement of 10 ns. Refer to parameters 40, 41 and 42 in the electrical specification of the desired device.

6.2.2 TIMER0 INCREMENT DELAY

Since the prescaler output is synchronized with the internal clocks, there is a small delay from the time the external clock edge occurs to the time the TMR0 is actually incremented. Figure 6-5 shows the delay from the external clock edge to the timer incrementing.

FIGURE 6-5: TIMER0 TIMING WITH EXTERNAL CLOCK



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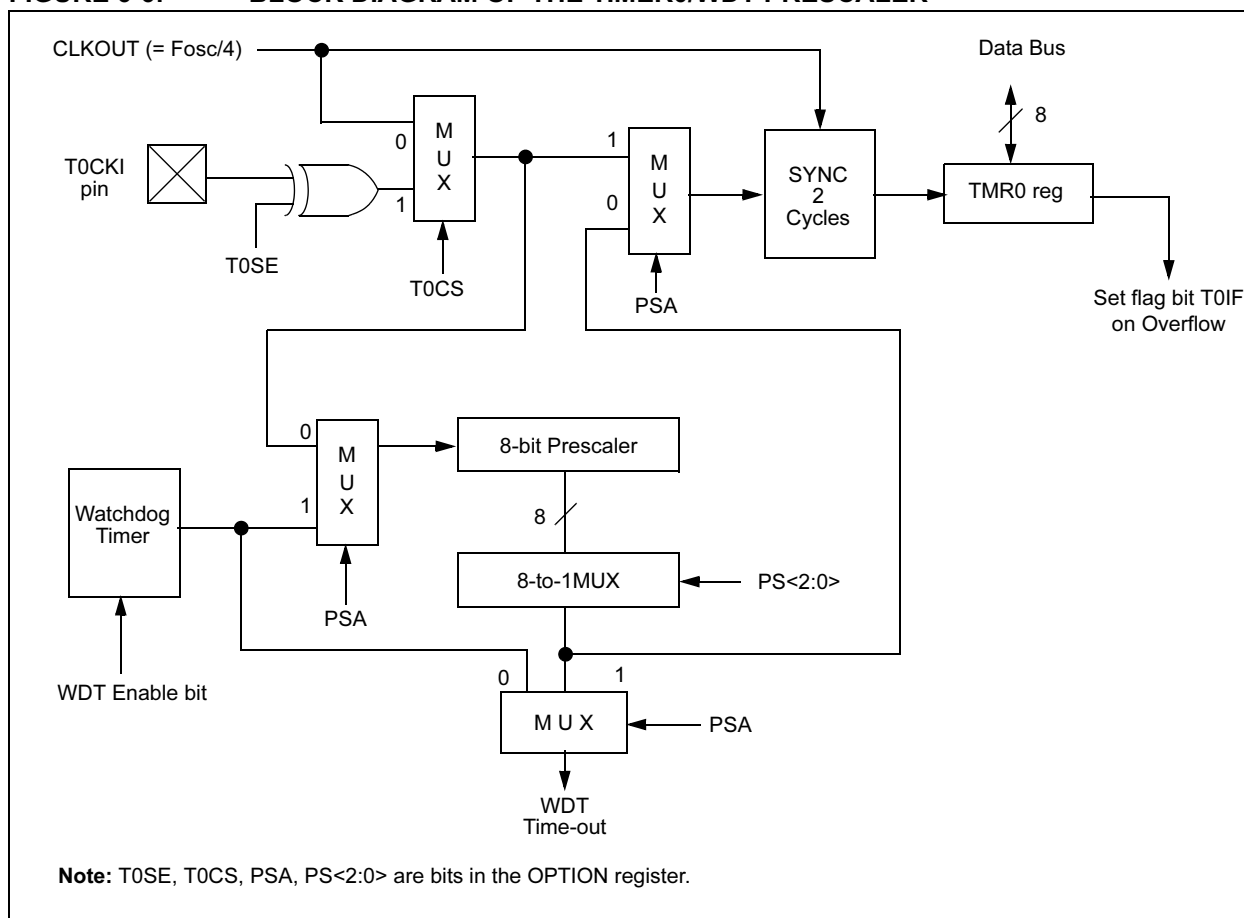
6.3 Prescaler

An 8-bit counter is available as a prescaler for the Timer0 module, or as a postscaler for the Watchdog Timer, respectively (Figure 6-6). For simplicity, this counter is being referred to as “prescaler” throughout this data sheet. Note that there is only one prescaler available which is mutually exclusive between the Timer0 module and the Watchdog Timer. Thus, a prescaler assignment for the Timer0 module means that there is no prescaler for the Watchdog Timer and vice-versa.

The PSA and PS<2:0> bits (OPTION<3:0>) determine the prescaler assignment and prescale ratio.

When assigned to the Timer0 module, all instructions writing to the TMR0 register (e.g., `CLRF 1`, `MOVWF 1`, `BSF 1,x....etc.`) will clear the prescaler. When assigned to WDT, a `CLRWDT` instruction will clear the prescaler along with the Watchdog Timer. The prescaler is not readable or writable.

FIGURE 6-6: BLOCK DIAGRAM OF THE TIMER0/WDT PRESCALER



6.3.1 SWITCHING PRESCALER ASSIGNMENT

The prescaler assignment is fully under software control (i.e., it can be changed “on-the-fly” during program execution). To avoid an unintended device RESET, the following instruction sequence (Example 6-1) must be executed when changing the prescaler assignment from Timer0 to WDT.)

EXAMPLE 6-1: CHANGING PRESCALER (TIMER0→WDT)

```

1.BCF      STATUS, RP0    ;Skip if already in
                           ;Bank 0
2.CLRWDT                      ;Clear WDT
3.CLRWF    TMR0           ;Clear TMR0 & Prescaler
4.BSF      STATUS, RP0    ;Bank 1
5.MOVLW    '00101111'b;   ;These 3 lines (5, 6, 7)
6.MOVWF    OPTION         ;are required only if
                           ;desired PS<2:0> are
7.CLRWDT                      ;000 or 001
8.MOVLW    '00101xxx'b    ;Set Postscaler to
9.MOVWF    OPTION         ;desired WDT rate
10.BCF     STATUS, RP0    ;Return to Bank 0
    
```

To change prescaler from the WDT to the TMR0 module, use the sequence shown in Example 6-2. This precaution must be taken even if the WDT is disabled.

EXAMPLE 6-2: CHANGING PRESCALER (WDT→TIMER0)

```

CLRWDT                      ;Clear WDT and
                           ;prescaler
BSF      STATUS, RP0
MOVLW    b'xxxx0xxx'       ;Select TMR0, new
                           ;prescale value and
                           ;clock source
MOVWF    OPTION_REG
BCF      STATUS, RP0
    
```

TABLE 6-1: REGISTERS ASSOCIATED WITH TIMER0

| Address | Name | Bit 7 | Bit 6 | Bit 5 | Bit 4 | Bit 3 | Bit 2 | Bit 1 | Bit 0 | Value on POR | Value on All Other RESETS |
|---------|--------|------------------------|--------|-------|--------|--------|--------|--------|--------|--------------|---------------------------|
| 01h | TMR0 | Timer0 module register | | | | | | | | xxxx xxxx | uuuu uuuu |
| 0Bh/8Bh | INTCON | GIE | PEIE | TOIE | INTE | RBIE | TOIF | INTF | RBIF | 0000 000x | 0000 000u |
| 81h | OPTION | RBPU | INTEDG | T0CS | T0SE | PSA | PS2 | PS1 | PS0 | 1111 1111 | 1111 1111 |
| 85h | TRISA | — | — | — | TRISA4 | TRISA3 | TRISA2 | TRISA1 | TRISA0 | ---1 1111 | ---1 1111 |

Legend: — = Unimplemented locations, read as '0', u = unchanged, x = unknown

Note: Shaded bits are not used by TMR0 module.

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9.4 Power-on Reset (POR), Power-up Timer (PWRT), Oscillator Start-up Timer (OST) and Brown-out Reset (BOR)

9.4.1 POWER-ON RESET (POR)

The on-chip POR circuit holds the chip in RESET until VDD has reached a high enough level for proper operation. To take advantage of the POR, just tie the MCLR pin through a resistor to VDD. This will eliminate external RC components usually needed to create Power-on Reset. A maximum rise time for VDD is required. See Electrical Specifications for details.

The POR circuit does not produce an internal RESET when VDD declines.

When the device starts normal operation (exits the RESET condition), device operating parameters (voltage, frequency, temperature, etc.) must be met to ensure operation. If these conditions are not met, the device must be held in RESET until the operating conditions are met.

For additional information, refer to Application Note AN607, "Power-up Trouble Shooting".

9.4.2 POWER-UP TIMER (PWRT)

The Power-up Timer provides a fixed 72 ms (nominal) time-out on power-up only, from POR or Brown-out Reset. The Power-up Timer operates on an internal RC oscillator. The chip is kept in RESET as long as PWRT is active. The PWRT delay allows the VDD to rise to an acceptable level. A configuration bit, **PWRT**, can disable (if set) or enable (if cleared or programmed) the Power-up Timer. The Power-up Timer should always be enabled when Brown-out Reset is enabled.

The Power-up Time delay will vary from chip-to-chip and due to VDD, temperature and process variation. See DC parameters for details.

9.4.3 OSCILLATOR START-UP TIMER (OST)

The Oscillator Start-Up Timer (OST) provides a 1024 oscillator cycle (from OSC1 input) delay after the PWRT delay is over. This ensures that the crystal oscillator or resonator has started and stabilized.

The OST time-out is invoked only for XT, LP and HS modes and only on Power-on Reset or wake-up from SLEEP.

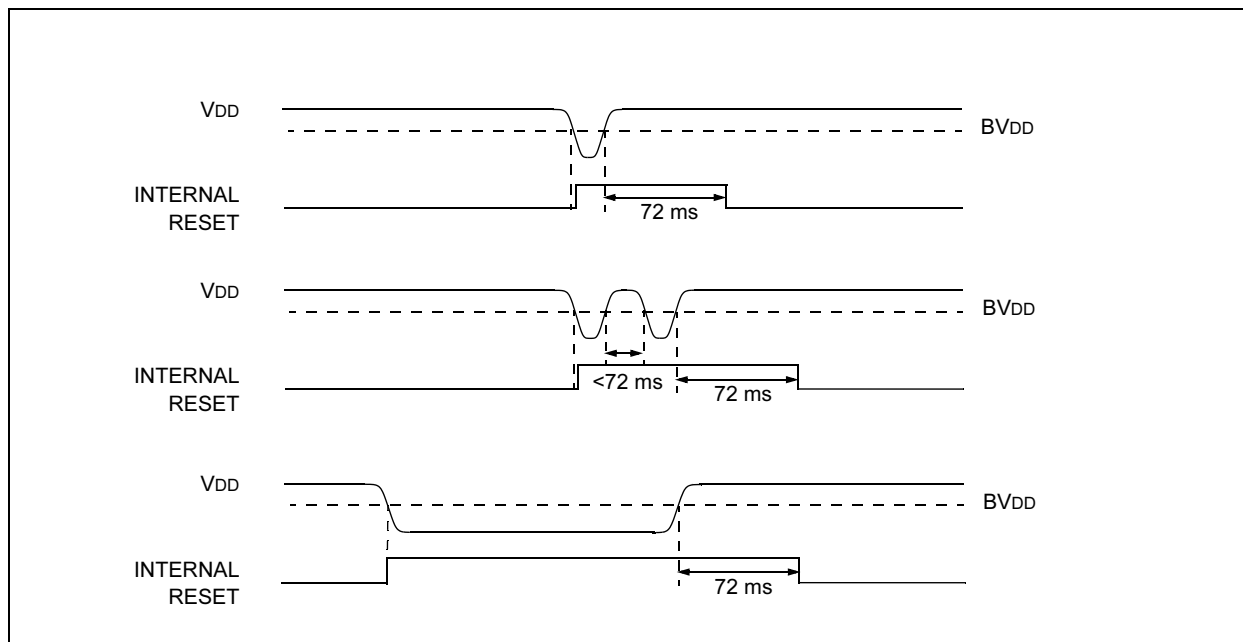
9.4.4 BROWN-OUT RESET (BOR)

The PIC16C62X members have on-chip Brown-out Reset circuitry. A configuration bit, **BODEN**, can disable (if clear/programmed) or enable (if set) the Brown-out Reset circuitry. If VDD falls below 4.0V refer to VBOR parameter D005 (VBOR) for greater than parameter (TBOR) in Table 12-5. The brown-out situation will RESET the chip. A RESET won't occur if VDD falls below 4.0V for less than parameter (TBOR).

On any RESET (Power-on, Brown-out, Watchdog, etc.) the chip will remain in RESET until VDD rises above BVDD. The Power-up Timer will now be invoked and will keep the chip in RESET an additional 72 ms.

If VDD drops below BVDD while the Power-up Timer is running, the chip will go back into a Brown-out Reset and the Power-up Timer will be re-initialized. Once VDD rises above BVDD, the Power-Up Timer will execute a 72 ms RESET. The Power-up Timer should always be enabled when Brown-out Reset is enabled. Figure 9-7 shows typical Brown-out situations.

FIGURE 9-7: BROWN-OUT SITUATIONS



9.8 Power-Down Mode (SLEEP)

The Power-down mode is entered by executing a SLEEP instruction.

If enabled, the Watchdog Timer will be cleared but keeps running, the PD bit in the STATUS register is cleared, the TO bit is set, and the oscillator driver is turned off. The I/O ports maintain the status they had, before SLEEP was executed (driving high, low, or hi-impedance).

For lowest current consumption in this mode, all I/O pins should be either at VDD or VSS with no external circuitry drawing current from the I/O pin and the comparators and VREF should be disabled. I/O pins that are hi-impedance inputs should be pulled high or low externally to avoid switching currents caused by floating inputs. The T0CKI input should also be at VDD or VSS for lowest current consumption. The contribution from on chip pull-ups on PORTB should be considered.

The MCLR pin must be at a logic high level (VIHMC).

Note: It should be noted that a RESET generated by a WDT time-out does not drive MCLR pin low.

The first event will cause a device RESET. The two latter events are considered a continuation of program execution. The \overline{TO} and \overline{PD} bits in the STATUS register can be used to determine the cause of device RESET. PD bit, which is set on power-up, is cleared when SLEEP is invoked. \overline{TO} bit is cleared if WDT wake-up occurred.

When the SLEEP instruction is being executed, the next instruction (PC + 1) is pre-fetched. For the device to wake-up through an interrupt event, the corresponding interrupt enable bit must be set (enabled). Wake-up is regardless of the state of the GIE bit. If the GIE bit is clear (disabled), the device continues execution at the instruction after the SLEEP instruction. If the GIE bit is set (enabled), the device executes the instruction after the SLEEP instruction and then branches to the interrupt address (0004h). In cases where the execution of the instruction following SLEEP is not desirable, the user should have an NOP after the SLEEP instruction.

Note: If the global interrupts are disabled (GIE is cleared), but any interrupt source has both its interrupt enable bit and the corresponding interrupt flag bits set, the device will immediately wake-up from SLEEP. The SLEEP instruction is completely executed.

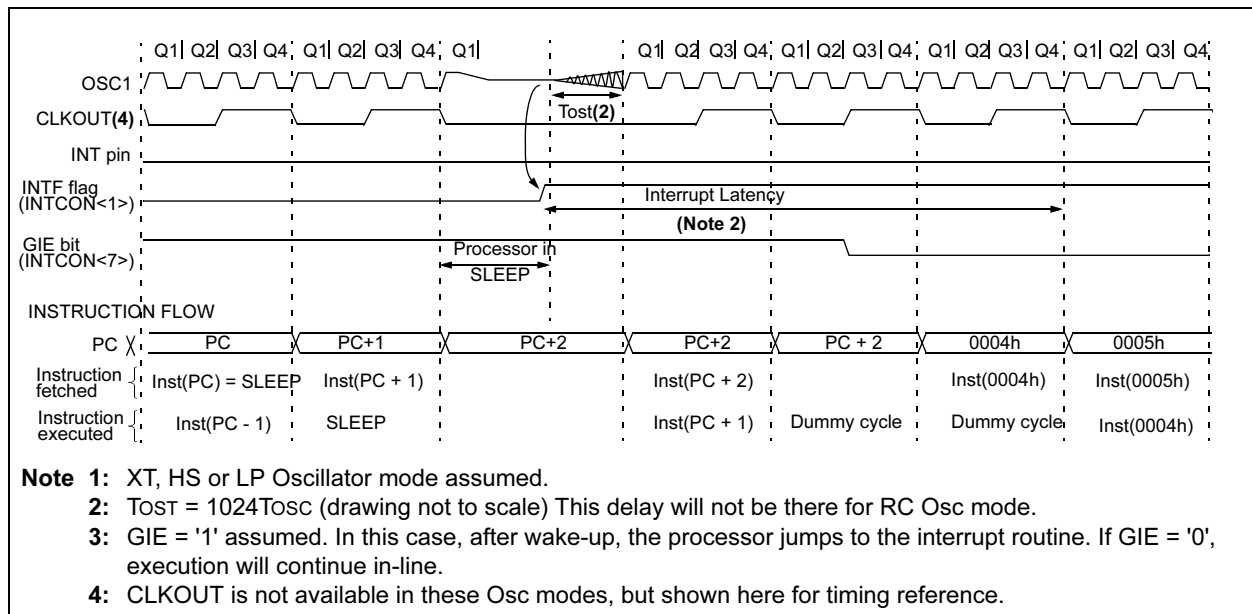
9.8.1 WAKE-UP FROM SLEEP

The device can wake-up from SLEEP through one of the following events:

1. External RESET input on MCLR pin
2. Watchdog Timer Wake-up (if WDT was enabled)
3. Interrupt from RB0/INT pin, RB Port change, or the Peripheral Interrupt (Comparator).

The WDT is cleared when the device wakes up from SLEEP, regardless of the source of wake-up.

FIGURE 9-18: WAKE-UP FROM SLEEP THROUGH INTERRUPT



PIC16C62X

TABLE 10-2: PIC16C62X INSTRUCTION SET

| Mnemonic, Operands | Description | Cycles | 14-Bit Opcode | | | | Status Affected | Notes | |
|--|-------------|------------------------------|---------------|----|------|------|--------------------|--------------------------------|-------|
| | | | MSb | | LSb | | | | |
| BYTE-ORIENTED FILE REGISTER OPERATIONS | | | | | | | | | |
| ADDWF | f, d | Add W and f | 1 | 00 | 0111 | dfff | ffff | C,DC,Z | 1,2 |
| ANDWF | f, d | AND W with f | 1 | 00 | 0101 | dfff | ffff | Z | 1,2 |
| CLRF | f | Clear f | 1 | 00 | 0001 | 1fff | ffff | Z | 2 |
| CLRW | - | Clear W | 1 | 00 | 0001 | 0000 | 0011 | Z | |
| COMF | f, d | Complement f | 1 | 00 | 1001 | dfff | ffff | Z | 1,2 |
| DECf | f, d | Decrement f | 1 | 00 | 0011 | dfff | ffff | Z | 1,2 |
| DECFSZ | f, d | Decrement f, Skip if 0 | 1(2) | 00 | 1011 | dfff | ffff | | 1,2,3 |
| INCF | f, d | Increment f | 1 | 00 | 1010 | dfff | ffff | Z | 1,2 |
| INCFSZ | f, d | Increment f, Skip if 0 | 1(2) | 00 | 1111 | dfff | ffff | | 1,2,3 |
| IORWF | f, d | Inclusive OR W with f | 1 | 00 | 0100 | dfff | ffff | Z | 1,2 |
| MOVF | f, d | Move f | 1 | 00 | 1000 | dfff | ffff | Z | 1,2 |
| MOVWF | f | Move W to f | 1 | 00 | 0000 | 1fff | ffff | | |
| NOP | - | No Operation | 1 | 00 | 0000 | 0xx0 | 0000 | | |
| RLF | f, d | Rotate Left f through Carry | 1 | 00 | 1101 | dfff | ffff | C | 1,2 |
| RRF | f, d | Rotate Right f through Carry | 1 | 00 | 1100 | dfff | ffff | C | 1,2 |
| SUBWF | f, d | Subtract W from f | 1 | 00 | 0010 | dfff | ffff | C,DC,Z | 1,2 |
| SWAPF | f, d | Swap nibbles in f | 1 | 00 | 1110 | dfff | ffff | | 1,2 |
| XORWF | f, d | Exclusive OR W with f | 1 | 00 | 0110 | dfff | ffff | Z | 1,2 |
| BIT-ORIENTED FILE REGISTER OPERATIONS | | | | | | | | | |
| BCF | f, b | Bit Clear f | 1 | 01 | 00bb | bfff | ffff | | 1,2 |
| BSF | f, b | Bit Set f | 1 | 01 | 01bb | bfff | ffff | | 1,2 |
| BTFSC | f, b | Bit Test f, Skip if Clear | 1 (2) | 01 | 10bb | bfff | ffff | | 3 |
| BTFSS | f, b | Bit Test f, Skip if Set | 1 (2) | 01 | 11bb | bfff | ffff | | 3 |
| LITERAL AND CONTROL OPERATIONS | | | | | | | | | |
| ADDLW | k | Add literal and W | 1 | 11 | 111x | kkkk | kkkk | C,DC,Z | |
| ANDLW | k | AND literal with W | 1 | 11 | 1001 | kkkk | kkkk | Z | |
| CALL | k | Call subroutine | 2 | 10 | 0kkk | kkkk | kkkk | | |
| CLRWDT | - | Clear Watchdog Timer | 1 | 00 | 0000 | 0110 | 0100 | $\overline{TO}, \overline{PD}$ | |
| GOTO | k | Go to address | 2 | 10 | 1kkk | kkkk | kkkk | | |
| IORLW | k | Inclusive OR literal with W | 1 | 11 | 1000 | kkkk | kkkk | Z | |
| MOVLW | k | Move literal to W | 1 | 11 | 00xx | kkkk | kkkk | | |
| RETFIE | - | Return from interrupt | 2 | 00 | 0000 | 0000 | 1001 | | |
| RETLW | k | Return with literal in W | 2 | 11 | 01xx | kkkk | kkkk | | |
| RETURN | - | Return from Subroutine | 2 | 00 | 0000 | 0000 | 1000 | | |
| SLEEP | - | Go into Standby mode | 1 | 00 | 0000 | 0110 | 0011 | $\overline{TO}, \overline{PD}$ | |
| SUBLW | k | Subtract W from literal | 1 | 11 | 110x | kkkk | kkkk | C,DC,Z | |
| XORLW | k | Exclusive OR literal with W | 1 | 11 | 1010 | kkkk | kkkk | Z | |

Note 1: When an I/O register is modified as a function of itself (e.g., `MOVF PORTB, 1`), the value used will be that value present on the pins themselves. For example, if the data latch is '1' for a pin configured as input and is driven low by an external device, the data will be written back with a '0'.

- If this instruction is executed on the TMR0 register (and, where applicable, d = 1), the prescaler will be cleared if assigned to the Timer0 Module.
- If Program Counter (PC) is modified or a conditional test is true, the instruction requires two cycles. The second cycle is executed as a NOP.

PIC16C62X

RETFIE Return from Interrupt

Syntax: [*label*] RETFIE

Operands: None

Operation: TOS → PC,
1 → GIE

Status Affected: None

Encoding:

| | | | |
|----|------|------|------|
| 00 | 0000 | 0000 | 1001 |
|----|------|------|------|

Description: Return from Interrupt. Stack is POPed and Top of Stack (TOS) is loaded in the PC. Interrupts are enabled by setting Global Interrupt Enable bit, GIE (INTCON<7>). This is a two-cycle instruction.

Words: 1

Cycles: 2

Example RETFIE

After Interrupt
PC = TOS
GIE = 1

RETLW Return with Literal in W

Syntax: [*label*] RETLW *k*

Operands: $0 \leq k \leq 255$

Operation: $k \rightarrow (W)$;
TOS → PC

Status Affected: None

Encoding:

| | | | |
|----|------|------|------|
| 11 | 01xx | kkkk | kkkk |
|----|------|------|------|

Description: The W register is loaded with the eight bit literal 'k'. The program counter is loaded from the top of the stack (the return address). This is a two-cycle instruction.

Words: 1

Cycles: 2

Example CALL TABLE;W contains
table

 ;offset value
TABLE • ;W now has table value
 •
 •
 ADDWF PC ;W = offset
 RETLW k1 ;Begin table
 RETLW k2 ;
 •
 •
 •
 RETLW kn ; End of table
Before Instruction
 W = 0x07
After Instruction
 W = value of k8

RETURN Return from Subroutine

Syntax: [*label*] RETURN

Operands: None

Operation: TOS → PC

Status Affected: None

Encoding:

| | | | |
|----|------|------|------|
| 00 | 0000 | 0000 | 1000 |
|----|------|------|------|

Description: Return from subroutine. The stack is POPed and the top of the stack (TOS) is loaded into the program counter. This is a two-cycle instruction.

Words: 1

Cycles: 2

Example RETURN

After Interrupt
PC = TOS

12.1 DC Characteristics: PIC16C62X-04 (Commercial, Industrial, Extended) PIC16C62X-20 (Commercial, Industrial, Extended) PIC16LC62X-04 (Commercial, Industrial, Extended) (CONT.)

| PIC16C62X | | Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial and $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended | | | | | |
|--------------|-------------------|--|-----|------|-----|---------------|-------------------------------------|
| PIC16LC62X | | Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial and $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended Operating voltage V_{DD} range is the PIC16C62X range. | | | | | |
| Param No. | Sym | Characteristic | Min | Typ† | Max | Units | Conditions |
| D022 | ΔI_{WDT} | WDT Current ⁽⁵⁾ | — | 6.0 | 20 | μA | $V_{DD}=4.0\text{V}$ (125°C) |
| D022A | ΔI_{BOR} | Brown-out Reset Current ⁽⁵⁾ | — | 350 | 425 | μA | BOD enabled, $V_{DD} = 5.0\text{V}$ |
| D023 | ΔI_{COMP} | Comparator Current for each Comparator ⁽⁵⁾ | — | — | 100 | μA | $V_{DD} = 4.0\text{V}$ |
| D023A | ΔI_{VREF} | VREF Current ⁽⁵⁾ | — | — | 300 | μA | $V_{DD} = 4.0\text{V}$ |
| D022 | ΔI_{WDT} | WDT Current ⁽⁵⁾ | — | 6.0 | 15 | μA | $V_{DD}=3.0\text{V}$ |
| D022A | ΔI_{BOR} | Brown-out Reset Current ⁽⁵⁾ | — | 350 | 425 | μA | BOD enabled, $V_{DD} = 5.0\text{V}$ |
| D023 | ΔI_{COMP} | Comparator Current for each Comparator ⁽⁵⁾ | — | — | 100 | μA | $V_{DD} = 3.0\text{V}$ |
| D023A | ΔI_{VREF} | VREF Current ⁽⁵⁾ | — | — | 300 | μA | $V_{DD} = 3.0\text{V}$ |
| 1A | FOSC | LP Oscillator Operating Frequency | 0 | — | 200 | kHz | All temperatures |
| | | RC Oscillator Operating Frequency | 0 | — | 4 | MHz | All temperatures |
| | | XT Oscillator Operating Frequency | 0 | — | 4 | MHz | All temperatures |
| | | HS Oscillator Operating Frequency | 0 | — | 20 | MHz | All temperatures |
| 1A | FOSC | LP Oscillator Operating Frequency | 0 | — | 200 | kHz | All temperatures |
| | | RC Oscillator Operating Frequency | 0 | — | 4 | MHz | All temperatures |
| | | XT Oscillator Operating Frequency | 0 | — | 4 | MHz | All temperatures |
| | | HS Oscillator Operating Frequency | 0 | — | 20 | MHz | All temperatures |

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which V_{DD} can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all I_{DD} measurements in Active Operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tri-stated, pulled to V_{DD} ,

MCLR = V_{DD} ; WDT enabled/disabled as specified.

3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to V_{DD} or V_{SS} .

4: For RC osc configuration, current through REXT is not included. The current through the resistor can be estimated by the formula: $I_r = V_{DD}/2R_{EXT}$ (mA) with R_{EXT} in k Ω .

5: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base I_{DD} or I_{PD} measurement.

12.2 DC Characteristics: PIC16C62XA-04 (Commercial, Industrial, Extended) PIC16C62XA-20 (Commercial, Industrial, Extended) PIC16LC62XA-04 (Commercial, Industrial, Extended) (CONT.)

| PIC16C62XA | | | Standard Operating Conditions (unless otherwise stated) | | | | |
|-------------|-----|-----------------------------------|--|------|-----|-------|---|
| | | | Operating temperature -40°C ≤ TA ≤ +85°C for industrial and 0°C ≤ TA ≤ +70°C for commercial and -40°C ≤ TA ≤ +125°C for extended | | | | |
| PIC16LC62XA | | | Standard Operating Conditions (unless otherwise stated) | | | | |
| | | | Operating temperature -40°C ≤ TA ≤ +85°C for industrial and 0°C ≤ TA ≤ +70°C for commercial and -40°C ≤ TA ≤ +125°C for extended | | | | |
| Param. No. | Sym | Characteristic | Min | Typ† | Max | Units | Conditions |
| D010 | IDD | Supply Current ^(2, 4) | — | 1.2 | 2.0 | mA | FOSC = 4 MHz, VDD = 5.5V, WDT disabled, XT mode, (Note 4)* |
| | | | — | 0.4 | 1.2 | mA | FOSC = 4 MHz, VDD = 3.0V, WDT disabled, XT mode, (Note 4)* |
| | | | — | 1.0 | 2.0 | mA | FOSC = 10 MHz, VDD = 3.0V, WDT disabled, HS mode, (Note 6) |
| | | | — | 4.0 | 6.0 | mA | FOSC = 20 MHz, VDD = 4.5V, WDT disabled, HS mode |
| | | | — | 4.0 | 7.0 | mA | FOSC = 20 MHz, VDD = 5.5V, WDT disabled*, HS mode |
| | | | — | 35 | 70 | μA | FOSC = 32 kHz, VDD = 3.0V, WDT disabled, LP mode |
| D010 | IDD | Supply Current ⁽²⁾ | — | 1.2 | 2.0 | mA | FOSC = 4 MHz, VDD = 5.5V, WDT disabled, XT mode, (Note 4)* |
| | | | — | — | 1.1 | mA | FOSC = 4 MHz, VDD = 2.5V, WDT disabled, XT mode, (Note 4) |
| | | | — | 35 | 70 | μA | FOSC = 32 kHz, VDD = 2.5V, WDT disabled, LP mode |
| D020 | IPD | Power-down Current ⁽³⁾ | — | — | 2.2 | μA | VDD = 3.0V |
| | | | — | — | 5.0 | μA | VDD = 4.5V* |
| | | | — | — | 9.0 | μA | VDD = 5.5V |
| | | | — | — | 15 | μA | VDD = 5.5V Extended Temp. |
| D020 | IPD | Power-down Current ⁽³⁾ | — | — | 2.0 | μA | VDD = 2.5V |
| | | | — | — | 2.2 | μA | VDD = 3.0V* |
| | | | — | — | 9.0 | μA | VDD = 5.5V |
| | | | — | — | 15 | μA | VDD = 5.5V Extended Temp. |

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered without losing RAM data.

2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in Active Operation mode are:

OSC1 = external square wave, from rail to rail; all I/O pins tri-stated, pulled to VDD,

MCLR = VDD; WDT enabled/disabled as specified.

3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD or VSS.

4: For RC osc configuration, current through REXT is not included. The current through the resistor can be estimated by the formula: $I_r = V_{DD}/2R_{EXT}$ (mA) with REXT in kΩ.

5: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

6: Commercial temperature range only.

12.4 DC Characteristics: PIC16C62X/C62XA/CR62XA (Commercial, Industrial, Extended) PIC16LC62X/LC62XA/LCR62XA (Commercial, Industrial, Extended) (CONT.)

| PIC16C62X/C62XA/CR62XA | | | Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial and $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended | | | | |
|---------------------------|-----------------|---|--|------|------------------------------------|-------|--|
| PIC16LC62X/LC62XA/LCR62XA | | | Standard Operating Conditions (unless otherwise stated) Operating temperature $-40^{\circ}\text{C} \leq T_A \leq +85^{\circ}\text{C}$ for industrial and $0^{\circ}\text{C} \leq T_A \leq +70^{\circ}\text{C}$ for commercial and $-40^{\circ}\text{C} \leq T_A \leq +125^{\circ}\text{C}$ for extended | | | | |
| Param. No. | Sym | Characteristic | Min | Typ† | Max | Units | Conditions |
| D040 | V _{IH} | Input High Voltage I/O ports with TTL buffer | 2.0V 0.25 V _{DD} + 0.8V | — | V _{DD} V _{DD} | V | V _{DD} = 4.5V to 5.5V otherwise (Note 1) |
| D041 | | with Schmitt Trigger input | 0.8 V _{DD} | — | V _{DD} | | |
| D042 | | MCLR RA4/T0CKI | 0.8 V _{DD} | — | V _{DD} | V | |
| D043 D043A | | OSC1 (XT, HS and LP) OSC1 (in RC mode) | 0.7 V _{DD} 0.9 V _{DD} | — | V _{DD} | V | |
| D070 | IPURB | PORTB weak pull-up current | 50 | 200 | 400 | μA | V _{DD} = 5.0V, V _{PIN} = V _{SS} |
| D070 | IPURB | PORTB weak pull-up current | 50 | 200 | 400 | μA | V _{DD} = 5.0V, V _{PIN} = V _{SS} |
| D060 | I _{IL} | Input Leakage Current ^(2, 3) I/O ports (Except PORTA) | | | ±1.0 | μA | V _{SS} ≤ V _{PIN} ≤ V _{DD} , pin at hi-impedance |
| D061 | | PORTA | — | — | ±0.5 | μA | V _{SS} ≤ V _{PIN} ≤ V _{DD} , pin at hi-impedance |
| D061 | | RA4/T0CKI | — | — | ±1.0 | μA | V _{SS} ≤ V _{PIN} ≤ V _{DD} |
| D063 | | OSC1, MCLR | — | — | ±5.0 | μA | V _{SS} ≤ V _{PIN} ≤ V _{DD} , XT, HS and LP osc configuration |
| D060 | I _{IL} | Input Leakage Current ^(2, 3) I/O ports (Except PORTA) | | | ±1.0 | μA | V _{SS} ≤ V _{PIN} ≤ V _{DD} , pin at hi-impedance |
| D061 | | PORTA | — | — | ±0.5 | μA | V _{SS} ≤ V _{PIN} ≤ V _{DD} , pin at hi-impedance |
| D061 | | RA4/T0CKI | — | — | ±1.0 | μA | V _{SS} ≤ V _{PIN} ≤ V _{DD} |
| D063 | | OSC1, MCLR | — | — | ±5.0 | μA | V _{SS} ≤ V _{PIN} ≤ V _{DD} , XT, HS and LP osc configuration |
| D080 | V _{OL} | Output Low Voltage I/O ports | — | — | 0.6 | V | I _{OL} = 8.5 mA, V _{DD} = 4.5V, -40° to $+85^{\circ}\text{C}$ |
| | | | — | — | 0.6 | V | I _{OL} = 7.0 mA, V _{DD} = 4.5V, $+125^{\circ}\text{C}$ |
| D083 | | OSC2/CLKOUT (RC only) | — | — | 0.6 | V | I _{OL} = 1.6 mA, V _{DD} = 4.5V, -40° to $+85^{\circ}\text{C}$ |
| | | | — | — | 0.6 | V | I _{OL} = 1.2 mA, V _{DD} = 4.5V, $+125^{\circ}\text{C}$ |

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5V, 25°C unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: In RC oscillator configuration, the OSC1 pin is a Schmitt Trigger input. It is not recommended that the PIC16C62X(A) be driven with external clock in RC mode.

2: The leakage current on the MCLR pin is strongly dependent on applied voltage level. The specified levels represent normal operating conditions. Higher leakage current may be measured at different input voltages.

3: Negative current is defined as coming out of the pin.

12.5 DC CHARACTERISTICS: PIC16C620A/C621A/C622A-40⁽⁷⁾ (Commercial) PIC16CR620A-40⁽⁷⁾ (Commercial)

| DC CHARACTERISTICS | | | Standard Operating Conditions (unless otherwise stated) | | | | |
|--------------------|------------------------|---|---|------|------|-------|---|
| | | | Operating temperature 0°C ≤ TA ≤ +70°C for commercial | | | | |
| Param No. | Sym | Characteristic | Min | Typ† | Max | Units | Conditions |
| D001 | VDD | Supply Voltage | 3.0 | — | 5.5 | V | FOSC = DC to 20 MHz |
| D002 | VDR | RAM Data Retention Voltage ⁽¹⁾ | — | 1.5* | — | V | Device in SLEEP mode |
| D003 | VPOR | VDD start voltage to ensure Power-on Reset | — | VSS | — | V | See section on Power-on Reset for details |
| D004 | SVDD | VDD rise rate to ensure Power-on Reset | 0.05* | — | — | V/ms | See section on Power-on Reset for details |
| D005 | VBOR | Brown-out Detect Voltage | 3.65 | 4.0 | 4.35 | V | BOREN configuration bit is cleared |
| D010 | IDD | Supply Current ^(2,4) | — | 1.2 | 2.0 | mA | FOSC = 4 MHz, VDD = 5.5V, WDT disabled, XT Osc mode, (Note 4)* |
| | | | — | 0.4 | 1.2 | mA | FOSC = 4 MHz, VDD = 3.0V, WDT disabled, XT Osc mode, (Note 4) |
| | | | — | 1.0 | 2.0 | mA | FOSC = 10 MHz, VDD = 3.0V, WDT disabled, HS Osc mode, (Note 6) |
| | | | — | 4.0 | 6.0 | mA | FOSC = 20 MHz, VDD = 4.5V, WDT disabled, HS Osc mode |
| | | | — | 4.0 | 7.0 | mA | FOSC = 20 MHz, VDD = 5.5V, WDT disabled*, HS Osc mode |
| | | | — | 35 | 70 | μA | FOSC = 32 kHz, VDD = 3.0V, WDT disabled, LP Osc mode |
| D020 | IPD | Power Down Current ⁽³⁾ | — | — | 2.2 | μA | VDD = 3.0V |
| | | | — | — | 5.0 | μA | VDD = 4.5V* |
| | | | — | — | 9.0 | μA | VDD = 5.5V |
| | | | — | — | 15 | μA | VDD = 5.5V Extended |
| D022 | ΔI _{WDT} | WDT Current ⁽⁵⁾ | — | 6.0 | 10 | μA | VDD = 4.0V |
| D022A | ΔI _{BOR} | Brown-out Reset Current ⁽⁵⁾ | — | 75 | 125 | μA | (125°C) |
| D023 | ΔI _{COMP} | Comparator Current for each Comparator ⁽⁵⁾ | — | 30 | 60 | μA | BOD enabled, VDD = 5.0V |
| D023A | ΔI _{VREF} | VREF Current ⁽⁵⁾ | — | 80 | 135 | μA | VDD = 4.0V |
| | ΔI _{EE Write} | Operating Current | — | — | 3 | mA | VCC = 5.5V, SCL = 400 kHz |
| | ΔI _{EE Read} | Operating Current | — | — | 1 | mA | |
| | ΔI _{EE} | Standby Current | — | — | 30 | μA | VCC = 3.0V, EE VDD = VCC |
| | ΔI _{EE} | Standby Current | — | — | 100 | μA | VCC = 3.0V, EE VDD = VCC |
| 1A | FOSC | LP Oscillator Operating Frequency | 0 | — | 200 | kHz | All temperatures |
| | | RC Oscillator Operating Frequency | 0 | — | 4 | MHz | All temperatures |
| | | XT Oscillator Operating Frequency | 0 | — | 4 | MHz | All temperatures |
| | | HS Oscillator Operating Frequency | 0 | — | 20 | MHz | All temperatures |

* These parameters are characterized but not tested.

† Data in "Typ" column is at 5.0V, 25°C, unless otherwise stated. These parameters are for design guidance only and are not tested.

Note 1: This is the limit to which VDD can be lowered in SLEEP mode without losing RAM data.

Note 2: The supply current is mainly a function of the operating voltage and frequency. Other factors such as I/O pin loading and switching rate, oscillator type, internal code execution pattern, and temperature also have an impact on the current consumption.

The test conditions for all IDD measurements in Active Operation mode are:

OSC1 = external square wave, from rail-to-rail; all I/O pins tri-stated, pulled to VDD; MCLR = VDD; WDT enabled/disabled as specified.

Note 3: The power-down current in SLEEP mode does not depend on the oscillator type. Power-down current is measured with the part in SLEEP mode, with all I/O pins in hi-impedance state and tied to VDD or VSS.

Note 4: For RC OSC configuration, current through REXT is not included. The current through the resistor can be estimated by the formula $I_r = V_{DD} / 2R_{EXT}$ (mA) with REXT in kΩ.

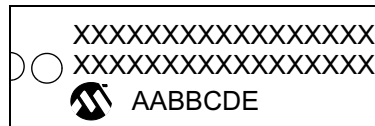
Note 5: The Δ current is the additional current consumed when this peripheral is enabled. This current should be added to the base IDD or IPD measurement.

Note 6: Commercial temperature range only.

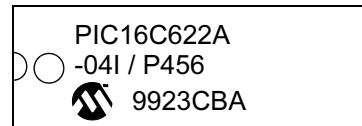
Note 7: See Section 12.1 and Section 12.3 for 16C62X and 16CR62X devices for operation between 20 MHz and 40 MHz for valid modified characteristics.

14.1 Package Marking Information

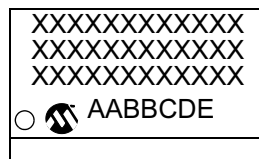
18-Lead PDIP



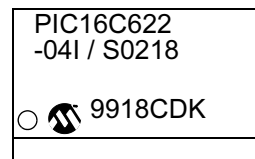
Example



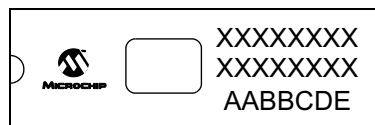
18-Lead SOIC (.300")



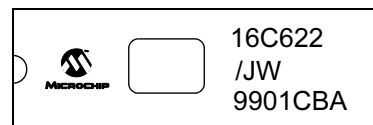
Example



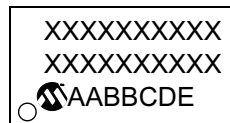
18-Lead Cerdip Windowed



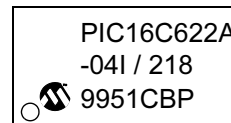
Example



20-Lead SSOP



Example



Legend: XX...X Customer specific information*
 Y Year code (last digit of calendar year)
 YY Year code (last 2 digits of calendar year)
 WW Week code (week of January 1 is week '01')
 NNN Alphanumeric traceability code

Note: In the event the full Microchip part number cannot be marked on one line, it will be carried over to the next line thus limiting the number of available characters for customer specific information.

* Standard PICmicro device marking consists of Microchip part number, year code, week code, and traceability code. For PICmicro device marking beyond this, certain price adders apply. Please check with your Microchip Sales Office. For QTP devices, any special marking adders are included in QTP price.

PIC16C62X

NOTES: